

Data Sheet

Description

The AP01C is a high voltage fast recovery diode of 1000 V / 0.2 A. The maximum $t_{\rm rr}$ of 200 ns is realized by optimizing a life-time control.

Features

| • | V _{RM} 1000 \ |
|---|--------------------------|
| • | I _{F(AV)} 0.2 A |
| | V _F 4.0 V |
| • | _{rr1} 200 n |

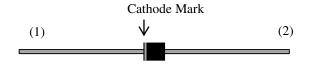
- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

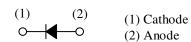
Applications

- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

Axial (φ 2.4 × 2.9L / φ 0.57)





Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

| Parameter | Symbol | Conditions | Rating | Unit |
|------------------------------------|--------------------|--|------------|--------|
| Nonrepetitive Peak Reverse Voltage | V_{RSM} | | 1050 | V |
| Repetitive Peak Reverse Voltage | V_{RM} | | 1000 | V |
| Average Forward Current | I _{F(AV)} | See Figure 2 and Figure 3 | 0.2 | A |
| Surge Forward Current | I_{FSM} | Half cycle sine wave, positive side, 10 ms, 1 shot | 5 | A |
| I ² t Limiting Value | I ² t | $1 \text{ ms} \le t \le 10 \text{ ms}$ | 0.125 | A^2s |
| Junction Temperature | T_{J} | | -40 to 150 | °C |
| Storage Temperature | T_{STG} | | -40 to 150 | °C |

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|--|----------------------|--|------|------|------|------|
| Forward Voltage Dron | V_{F} | $T_J = 25 ^{\circ}\text{C}, I_F = 0.2 \text{A}$ | _ | _ | 4.0 | V |
| Forward Voltage Drop | | $T_J = 100 ^{\circ}\text{C}, I_F = 0.2 \text{A}$ | _ | 1.6 | _ | V |
| Reverse Leakage Current | I_R | $V_R = V_{RM}$ | _ | _ | 100 | μΑ |
| Reverse Leakage Current under High Temperature | $H \cdot I_R$ | $V_R = V_{RM}, T_J = 100 ^{\circ}C$ | _ | _ | 500 | μA |
| Decrees Decrees Time | t _{rr1} | $I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$ | _ | _ | 200 | ns |
| Reverse Recovery Time | t _{rr2} | $I_F = 100 \text{ mA}, I_{RP} = 200 \text{ mA},$ 75% recovery point, $T_J = 25 \text{ °C}$ | — | — | 80 | ns |
| Thermal Resistance (1) | R _{th(J-L)} | See Figure 1. | — | | 22 | °C/W |

Mechanical Characteristics

| Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------------|------------|------|------|------|------|
| Package Weight | | _ | 0.17 | _ | g |

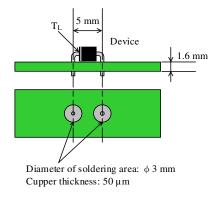
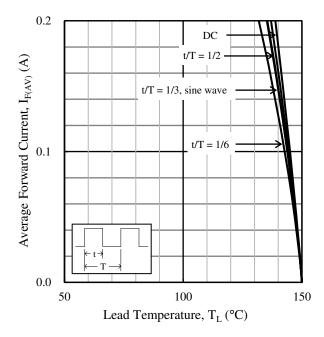
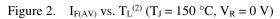


Figure 1. Lead Temperature Measurement Conditions

 $^{^{(1)}}R_{th\,(J-L)}$ is thermal resistance between junction and lead. Lead temperature (T_L) is measured near the root of pin (see Figure 1).

Derating Curves





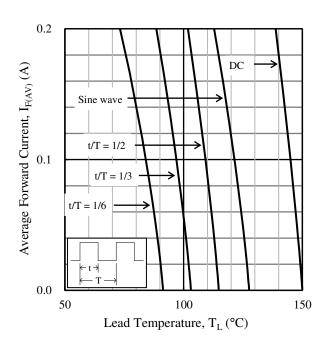


Figure 3. $I_{F(AV)}$ vs. $T_L^{(2)}$ ($T_J = 150$ °C, $V_R = 1000$ V)

⁽²⁾ See Figure 1 for the lead temperature measurement conditions.

Characteristic Curves

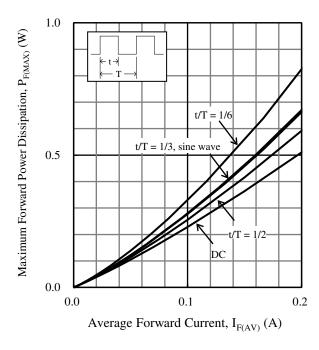


Figure 4. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

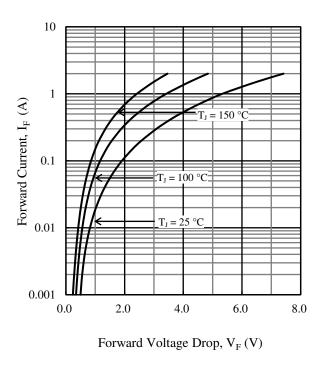


Figure 6. Typical Characteristics: I_F vs. V_F

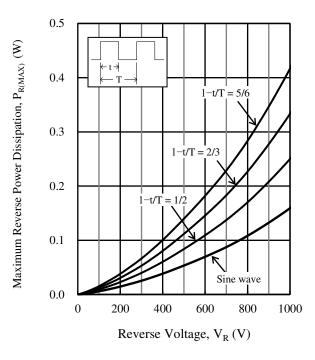


Figure 5. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

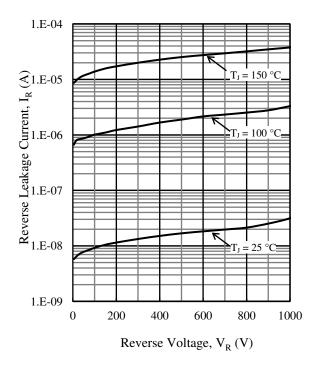


Figure 7. Typical Characteristics: I_R vs. V_R

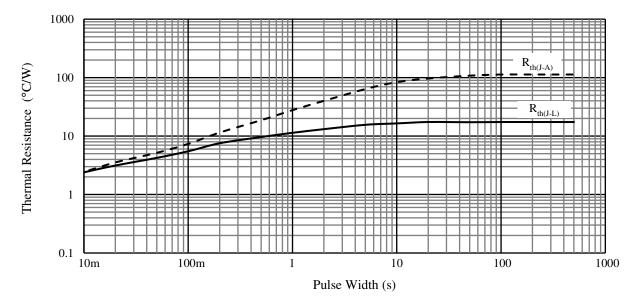
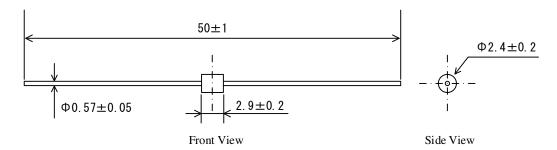


Figure 8. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

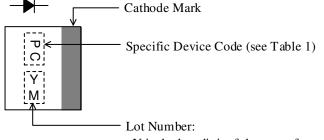
• Axial $(\phi 2.4 \times 2.9 L / \phi 0.57)$



NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- The total length of the product is the dimension when delivered separately and depends on the taping and lead forming specifications.
- The allowance position of body against the center of the total length of the product is 0.5 mm (max.); see Front View.
- The allowance position of lead against the center of body is 0.2 mm (max.); see Side View.
- The burr may exist up to 2 mm from the body of lead root.
- When soldering the products, it is required to minimize the working time within the following limits:
 Flow: 260 °C / 10 s, 1 time
 Soldering Iron: 350 °C / 3.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Marking Diagram



Y is the last digit of the year of manufacture (0 to 9) M is the month of the year (1 to 9, O, N or D)

Table 1. Specific Device Code

| Specific Device Code | Part Number |
|----------------------|-------------|
| PC | AP01C |

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